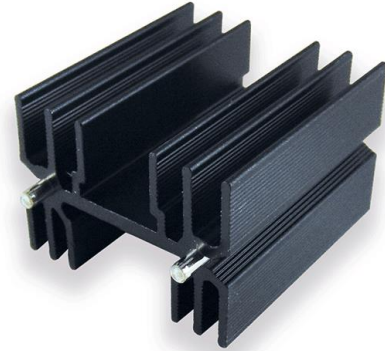


Product Data Sheet Type: **PR31/38/MC**

Group: HEATSINKS Board Level

For single mounting

Width : 35 mm
 Height : 25.4 mm
 Length : 38 mm
 Minimum thermal resistance : 7,2 K/W
 For device : TO 220|TO 218|TOP 3
 Device mounted by : Clip Mounting
 Heatsink mounted by : Solder
 Surface : Black Anodised
 Material : AlMgSi0,5



- Special extruded heatsink for semiconductor case TO220, TO218(TOP3)
- Aluminium, anodised black, solderable
- Standard heights: 38, 50 and 63 mm
- Version MC (Mounting clip) for clip mounting of semiconductor.
- Heatsink solderable by tin plated solder pins

